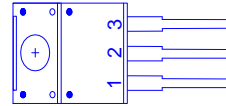
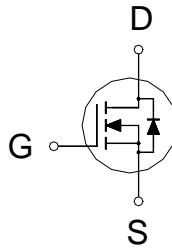




PRODUCT SUMMARY

| | | |
|---------------|--------------|-------|
| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | I_D |
| 700V | 0.91Ω | 10A |



- 1. GATE
- 2. DRAIN
- 3. SOURCE

100% UIS tested

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|--|-----------------------|----------------|------------|-------|
| Drain-Source Voltage | | V_{DS} | 700 | V |
| Gate-Source Voltage | | V_{GS} | ±30 | V |
| Continuous Drain Current ^{2,4} | $T_C = 25\text{ °C}$ | I_D | 10 | A |
| | $T_C = 100\text{ °C}$ | | 6 | |
| Pulsed Drain Current ^{1, 2} | | I_{DM} | 30 | |
| Avalanche Current ³ | | I_{AS} | 5 | A |
| Avalanche Energy ³ | | E_{AS} | 125 | mJ |
| Power Dissipation | $T_C = 25\text{ °C}$ | P_D | 46 | W |
| | $T_C = 100\text{ °C}$ | | 18 | |
| Operating Junction & Storage Temperature Range | | T_j, T_{stg} | -55 to 150 | °C |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|---------------------|-----------------|---------|---------|--------|
| Junction-to-Case | $R_{\theta JC}$ | | 2.7 | °C / W |
| Junction-to-Ambient | $R_{\theta JA}$ | | 62.5 | °C / W |

¹Pulse width limited by maximum junction temperature.

²Limited only by maximum temperature allowed.

³ $V_{DD} = 50V$, $L = 10mH$, starting $T_J = 25\text{ °C}$.

⁴This characteristics assumes the die are assembled in TO-220 packages.

ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ °C}$, Unless Otherwise Noted)

| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNIT |
|--------------------------------|---------------|-----------------------------------|--------|-----|------|------|
| | | | MIN | TYP | MAX | |
| STATIC | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$ | 700 | | | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 2 | 2.8 | 4 | |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0V, V_{GS} = \pm 30V$ | | | ±100 | nA |

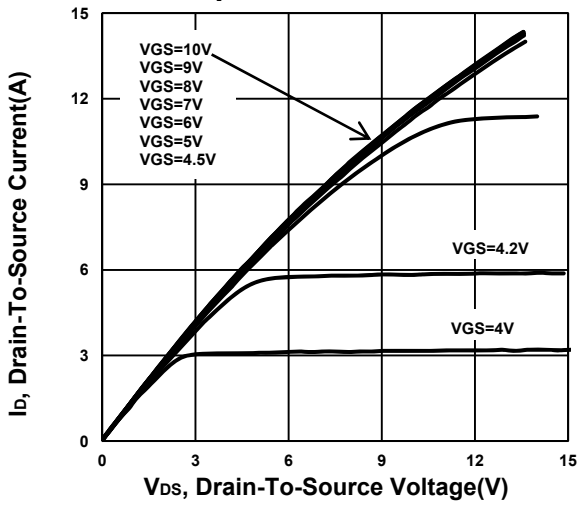
| | | | | | | |
|---|--------------|---|--|------|------|---------------|
| Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 700V, V_{GS} = 0V, T_C = 25\text{ }^\circ\text{C}$ | | | 1 | μA |
| | | $V_{DS} = 560V, V_{GS} = 0V, T_C = 100\text{ }^\circ\text{C}$ | | | 100 | |
| Drain-Source On-State Resistance ¹ | $R_{DS(ON)}$ | $V_{GS} = 10V, I_D = 5A$ | | 0.77 | 0.91 | Ω |
| Forward Transconductance ¹ | g_{fs} | $V_{DS} = 10V, I_D = 5A$ | | 13 | | S |
| DYNAMIC | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0V, V_{DS} = 25V, f = 1\text{MHz}$ | | 2039 | | pF |
| Output Capacitance | C_{oss} | | | 154 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 8 | | |
| Gate Resistance | R_g | $V_{GS} = 0V, V_{DS} = 0V, f = 1\text{MHz}$ | | 1.4 | | Ω |
| Total Gate Charge ² | Q_g | $V_{DD} = 560V, I_D = 10A, V_{GS} = 10V$ | | 43 | | nC |
| Gate-Source Charge ² | Q_{gs} | | | 8.4 | | |
| Gate-Drain Charge ² | Q_{gd} | | | 11 | | |
| Turn-On Delay Time ² | $t_{d(on)}$ | $V_{DD} = 350V, I_D = 10A, R_G = 25\Omega$ | | 38 | | nS |
| Rise Time ² | t_r | | | 41 | | |
| Turn-Off Delay Time ² | $t_{d(off)}$ | | | 141 | | |
| Fall Time ² | t_f | | | 73 | | |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$) | | | | | | |
| Continuous Current ³ | I_S | | | | 10 | A |
| Forward Voltage ¹ | V_{SD} | $I_F = 10A, V_{GS} = 0V$ | | | 1.4 | V |
| Reverse Recovery Time | t_{rr} | $I_F = 10A, di_F/dt = 100A / \mu\text{S}$ | | 423 | | nS |
| Reverse Recovery Charge | Q_{rr} | | | 5.8 | | μC |

¹Pulse test : Pulse Width $\leq 380\text{ }\mu\text{sec}$, Duty Cycle $\leq 2\%$.

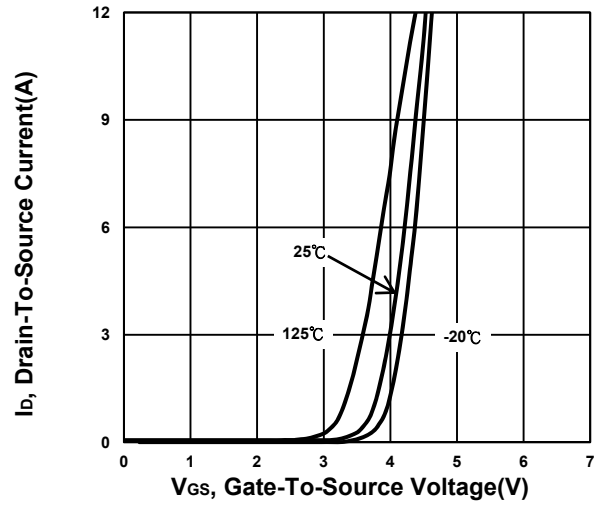
²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

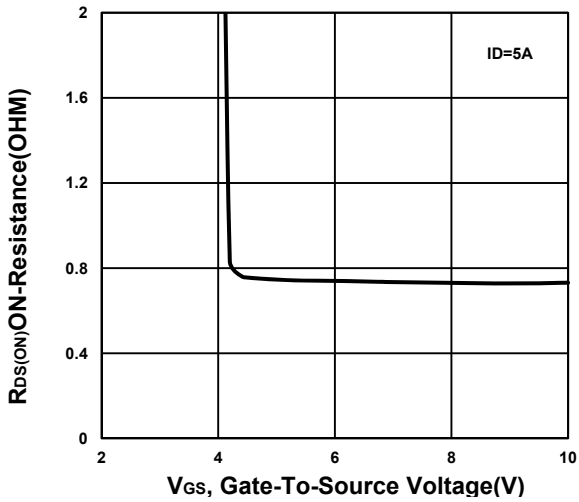
Output Characteristics



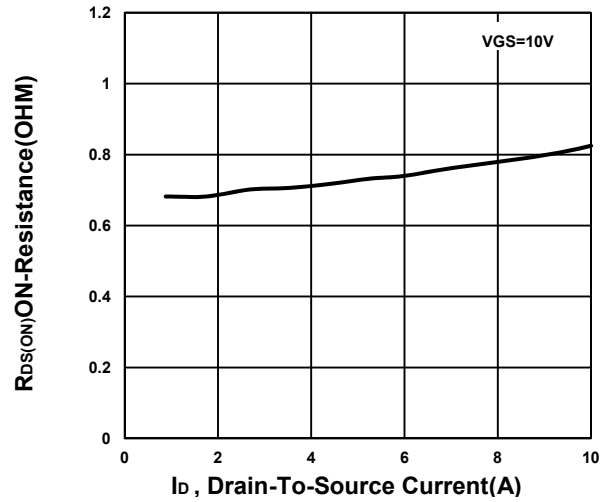
Transfer Characteristics



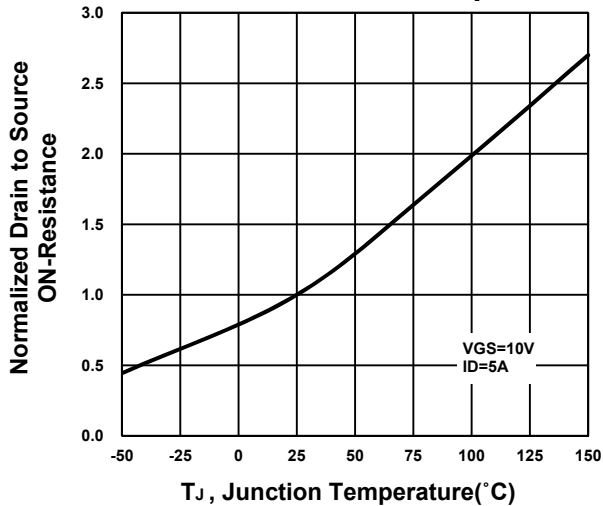
On-Resistance VS Gate-To-Source



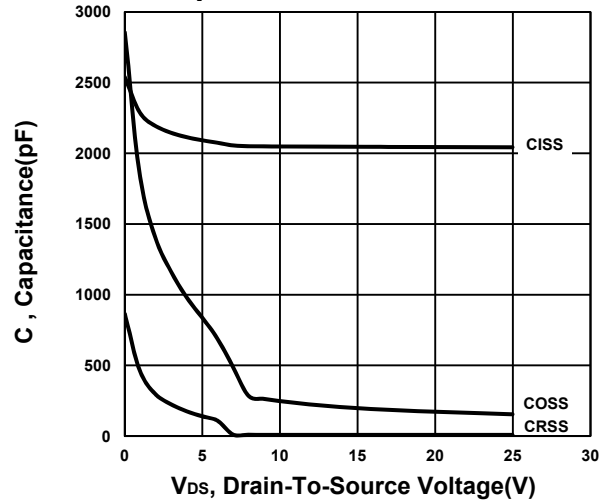
On-Resistance VS Drain Current



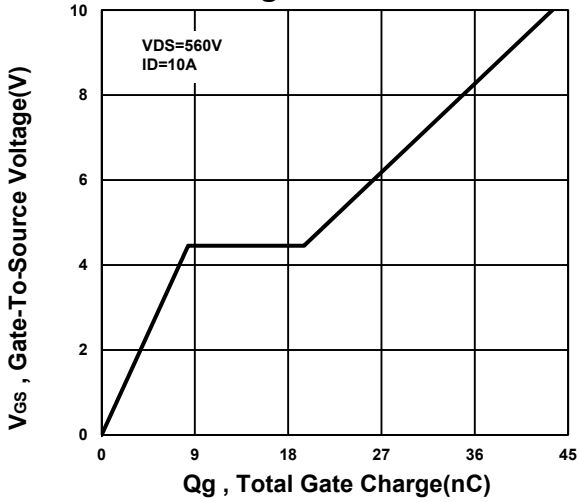
On-Resistance VS Temperature



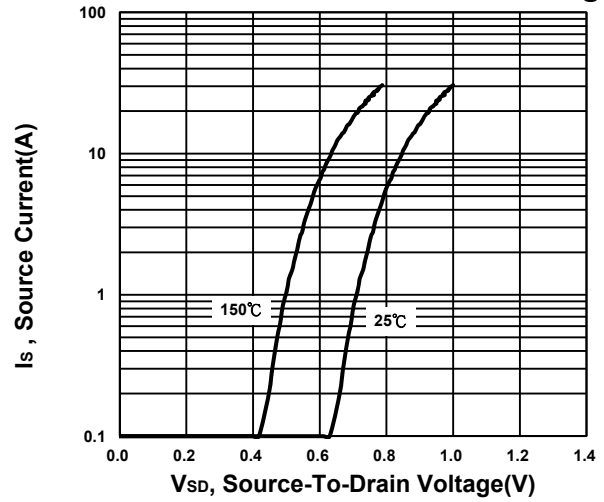
Capacitance Characteristic



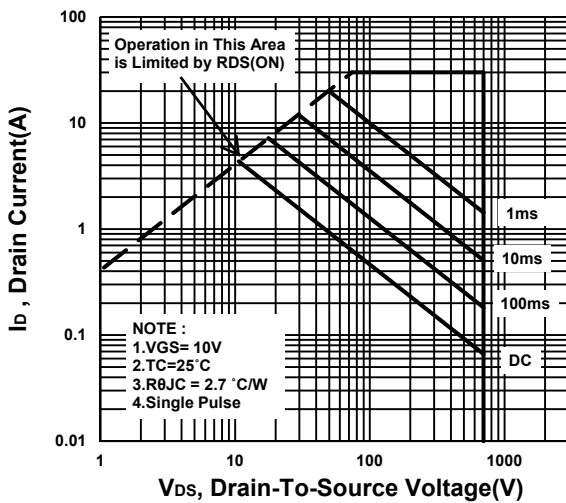
Gate charge Characteristics



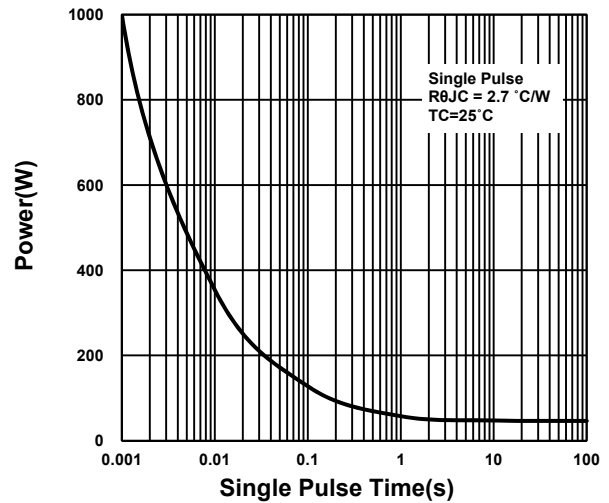
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

